

Report No. MCR-22-0660 Oct. 03,2022

RENESAS SEMICONDUCTOR RELIABILITY REPORT

- GROUP : 78K0RKJ3
- DEVICE : Refer to Product List
- APPLICATION : Consumer / Industry

Quality Assurance Div. Renesas Electronics Corporation



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Table. Reliability test results (QFP)

Test Items Refere		Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 $^\circ$ C to 150 $^\circ$ C , 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Solderability (SD)	J-STD-002	245 ℃, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

*1) With preconditioning per JESD22-A113, MSL 3

•It is tested to confirm that all the samples are satisfied with an individual product specification.

Note :

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .



The failure rate of the device in an actual use condition can be estimated by the below procedure.

• Equation for the failure rate estimation (λ)

 $\lambda = \lambda b \times \pi T$ (FIT)

(1)Unique failure rate (λ b)

λb= 8.19 FIT

Unique failure rate at Ta=55 $^{\circ}$ C using 60 $^{\circ}$ confidence level.

②Temperature term (π T)

 π T=exp{11600×Ea×(1/(273+55)-1/(273+Ta))}

Ea : Activation energy (eV)

Ta : Ambient temperature ($^{\circ}$ C)

[π T simplified chart as Ea=0.7 eV												
	Ta (℃)	40	50	55	60	65	70	75	80	85	90	100	110
	πT	0.31	0.68	1	1.45	2.08	2.95	4.15	5.77	7.96	10.88	19.82	34.99

•MTTF (Mean Time To Failure)

 $MTTF = 1/\lambda$



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Reference about Renesas package code

Package type	Package code *1	
Lead type plastic package	QFP	PxQP
	SOP	PxSP
Non-lead type plastic package	QFN	PxQN
Grid array type plastic package	BGA	PxBG
	LGA	PxLG

*1. First four digit

Table. Product list

			Dackago cada	No	Croup	Draduct part number	Dackago cada
No 1	Group 78K0RKJ3	Product part number UPD78F1184AGJ(R)-GAE-AX	Package code	No 51	Group	Product part number	Package code
1 2	78K0RKJ3 78K0RKJ3	UPD78F1184AGJ(R)-XXX-GAE-AX	· ·	51	1		
2	78K0RKJ3	UPD78F1184AGJ(S)-XXX-GAE-AX		53			
4	78K0RKJ3	UPD78F1184AGJ-GAE-AX		54			
+ 5	78K0RKJ3	UPD78F1184AGJ-XXX-GAE-AX	6	55			
6	78K0RKJ3	UPD78F1185AGJ(R)-XXX-GAE-AX		56			
7	78K0RKJ3	UPD78F1185AGJ(S)-XXX-GAE-AX		57			
7 8	78K0RKJ3	UPD78F1185AGJ-GAE-AX		58			
8 9	78K0RKJ3	UPD78F1185AGJ-XXX-GAE-AX		59			
9 10	78K0RKJ3	UPD78F1186AGJ(R)-GAE-AX		60			
11	78K0RKJ3	UPD78F1186AGJ(R)-XXX-GAE-AX		61			
12	78K0RKJ3	UPD78F1186AGJ(S)-GAE-AX		62			
12	78K0RKJ3	UPD78F1186AGJ(S)-XXX-GAE-AX		63			
13 14				64			
14 15	78K0RKJ3	UPD78F1186AGJ-GAE-AX		65			
15 16	78K0RKJ3	UPD78F1186AGJ-XXX-GAE-AX					
16 17	78K0RKJ3	UPD78F1187AGJ(R)-GAE-AX		66			
	78K0RKJ3	UPD78F1187AGJ(R)-XXX-GAE-AX		67			
18	78K0RKJ3	UPD78F1187AGJ(S)-XXX-GAE-AX		68			
19	78K0RKJ3	UPD78F1187AGJ-GAE-AX		69			
20	78K0RKJ3	UPD78F1187AGJ-XXX-GAE-AX		70			
21	78K0RKJ3	UPD78F1188AGJ(R)-GAE-AX		71			
22	78K0RKJ3	UPD78F1188AGJ(R)-XXX-GAE-AX		72			
23	78K0RKJ3	UPD78F1188AGJ(S)-XXX-GAE-AX		73			
24	78K0RKJ3	UPD78F1188AGJ-GAE-AX		74			
25 26	78K0RKJ3	UPD78F1188AGJ-XXX-GAE-AX	PLQP0144*	75			
				76			
27				77			
28				78			
29 30				79 80			
31				81			
32				82			
33				83			
34 25				84			
35				85			
36 37				86 87			
38				88 89			
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44 4 F				94			
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				96			
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48				98			
49 50				99			
50				100			